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Vishay Siliconix

N-Channel 100 V (D-S) MOSFET

PowerPAK® SC-70-6L Single D D S D G Top View Bottom View

| PRODUCT SUMMARY | | | | | | | | | |
|--|--------|--|--|--|--|--|--|--|--|
| V _{DS} (V) | 100 | | | | | | | | |
| $R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$ | 0.055 | | | | | | | | |
| $R_{DS(on)}$ max. (Ω) at $V_{GS} = 7.5 \text{ V}$ | 0.072 | | | | | | | | |
| Q _g typ. (nC) | 6.5 | | | | | | | | |
| I _D (A) ^a | 12 | | | | | | | | |
| Configuration | Single | | | | | | | | |

FEATURES

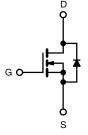
- TrenchFET® Gen IV power MOSFET
- Tuned for the lowest R_{DS} Q_{oss}
- 100% R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Primary side switch
- DC/DC converter
- Motor drive switch
- Boost converter
- LED backlighting



N-Channel MOSFET

| ORDERING INFORMATION | |
|---------------------------------|-----------------|
| Package | PowerPAK SC-70 |
| Lead (Pb)-free and halogen-free | SiA110DJ-T1-GE3 |

| PARAMETER | | SYMBOL | LIMIT | UNIT | | |
|--|-----------------------------------|-----------------|-----------------|------|--|--|
| Drain-source voltage | | V _{DS} | 100 | V | | |
| Gate-source voltage | | V_{GS} | ± 20 | V | | |
| | T _C = 25 °C | | 12 ^a | | | |
| Continuous dusin surrent (T. 150 °C) | T _C = 70 °C | | 10 | | | |
| Continuous drain current (T _J = 150 °C) | T _A =25 °C | I _D | 5.4 b, c | | | |
| | T _A = 70 °C | | 4.3 b, c | Α | | |
| Pulsed drain current (t = 100 μs) | • | I _{DM} | 20 | | | |
| Continuous accuracy during displacement | T _C = 25 °C | | 12 ^a | | | |
| Continuous source-drain diode current | T _A = 70 °C | I _S | 2.9 b, c | | | |
| Single pulse avalanche current | . 0.1 | I _{AS} | 10 | | | |
| Single pulse avalanche energy | L = 0.1 mH | E _{AS} | 5 | mJ | | |
| | T _C = 25 °C | | 19 | | | |
| Manipular and a state of the state of | T _C = 70 °C | | 12 | \A/ | | |
| Maximum power dissipation | T _A = 25 °C | P _D | 3.5 b, c | W | | |
| | T _A = 70 °C | | 2.2 b, c | | | |
| Operating junction and storage temperature | T _J , T _{stg} | -55 to +150 | | | | |
| Soldering recommendations (peak tempera | ture) ^{d, e} | | 260 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | | | | | |
|----------------------------------|--------------|-------------------|---------|---------|------|--|--|--|--|
| PARAMETER | | SYMBOL | TYPICAL | MAXIMUM | UNIT | | | | |
| Maximum junction-to-ambient b, f | t ≤ 5 s | R _{thJA} | 28 | 36 | °C/M | | | | |
| Maximum junction-to-case (drain) | Steady state | R _{thJC} | 5.3 | 6.5 | °C/W | | | | |

Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. See solder profile (www.vishay.com/ppg?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- f. Maximum under steady state conditions is 80 °C/W



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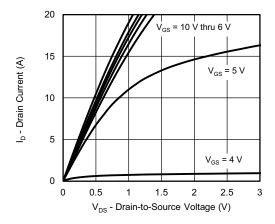
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT | |
|---|--|--|------|-------|-------|------|--|
| Static | | | | | • | | |
| Drain-source breakdown voltage | V_{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 100 | - | - | V | |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | I _D = 10 mA | - | 57 | - | 140 | |
| V _{GS(th)} temperature coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | - | -7.2 | - | mV/° | |
| Gate-source threshold voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 2 | - | 4 | V | |
| Gate-source leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | - | - | 100 | nA | |
| Zana mata walta na alunin awamat | | V _{DS} = 100 V, V _{GS} = 0 V | - | - | 1 | μΑ | |
| Zero gate voltage drain current | I _{DSS} | V _{DS} = 100 V, V _{GS} = 0 V, T _J = 70 °C | - | - | 10 | | |
| On-state drain current ^a | I _{D(on)} | $V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$ | 10 | - | - | Α | |
| Drain actives on etata registance 3 | В | V _{GS} = 10 V, I _D = 4 A | - | 0.046 | 0.055 | | |
| Drain-source on-state resistance ^a | R _{DS(on)} | $V_{GS} = 7.5 \text{ V}, I_D = 4 \text{ A}$ | - | 0.051 | 0.072 | Ω | |
| Forward transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 10 A | - | 25 | - | S | |
| Dynamic ^b | | | | | | | |
| Input capacitance | C _{iss} | | - | 550 | - | pF | |
| Output capacitance | C _{oss} | $V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | - | 50 | - | | |
| Reverse transfer capacitance | C _{rss} | | - | 7 | - | | |
| Tatal asta shawa | 0 | $V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 4 \text{ A}$ | - | 8.5 | 13 | nC | |
| Total gate charge | Q_g | | - | 6.5 | 10 | | |
| Gate-source charge | Q _{gs} | $V_{DS} = 50 \text{ V}, V_{GS} = 7.5 \text{ V}, I_D = 4 \text{ A}$ | - | 2.5 | - | | |
| Gate-drain charge | Q _{gd} | | - | 1.5 | - | | |
| Output charge | Q _{oss} | $V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}$ | - | 8 | - | | |
| Gate resistance | R_g | f = 1 MHz | 0.3 | 1.3 | 2.6 | Ω | |
| Turn-on delay time | t _{d(on)} | | - | 10 | 20 | | |
| Rise time | t _r | $V_{DD} = 50 \text{ V}, \text{ R}_{L} = 12.5 \Omega, \text{ I}_{D} \cong 4 \text{ A},$ | - | 5 | 10 | 1 | |
| Turn-off delay time | t _{d(off)} | $V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$ | - | 14 | 30 | 1 | |
| Fall time | t _f | | - | 5 | 10 | 1 | |
| Turn-on delay time | t _{d(on)} | | - | 11 | 20 | ns | |
| Rise time | t _r | | | 5 | 10 | 1 | |
| Turn-off delay time | t _{d(off)} | $V_{GEN} = 7.5 \text{ V}, R_g = 1 \Omega$ | - | 14 | 30 | 1 | |
| Fall time | ` ' | | | | | | |
| Drain-Source Body Diode Characteristi | cs | | | | | • | |
| Continuous source-drain diode current | I _S | T _C = 25 °C | - | - | 12 | | |
| Pulse diode forward current | I _{SM} | | - | - | 20 | A | |
| Body diode voltage | V_{SD} | I _S = 4 A, V _{GS} = 0 V | - | 0.85 | 1.2 | V | |
| Body diode reverse recovery time | t _{rr} | | - | 50 | 100 | ns | |
| Body diode reverse recovery charge | Q _{rr} | 1 4 4 4:/4t 400 4 / - T 05 20 | - | 55 | 110 | nC | |
| Reverse recovery fall time | $I_{\rm F} = 4$ A, di/dt = 100 A/µs, $I_{\rm L} = 25$ °C | | | | - | | |
| Reverse recovery rise time | t _b | | - | 23 | - | ns | |

Notes

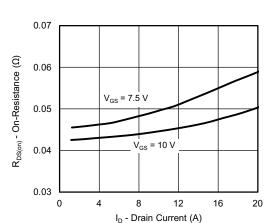
- a. Pulse test: pulse width \leq 300 μ s, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

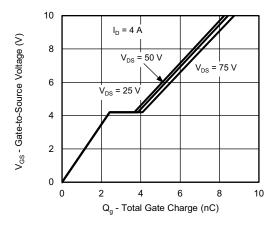




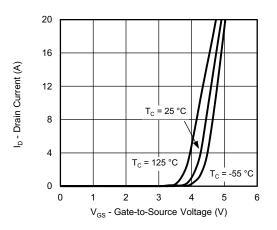
Output Characteristics



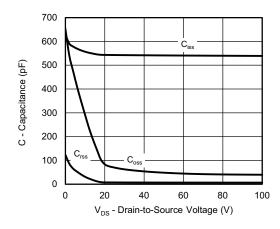
On-Resistance vs. Drain Current and Gate Voltage



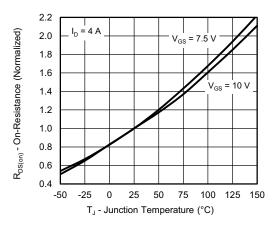
Gate Charge



Transfer Characteristics

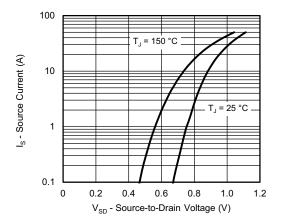


Capacitance

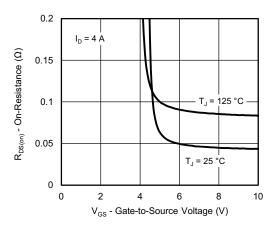


On-Resistance vs. Junction Temperature

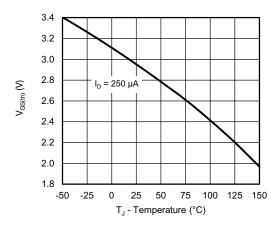




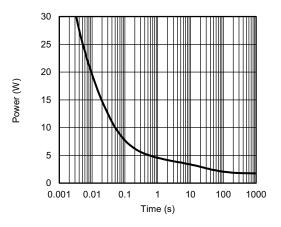
Source-Drain Diode Forward Voltage



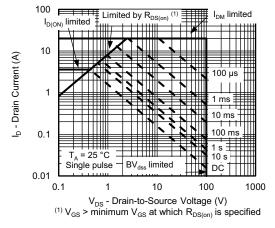
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

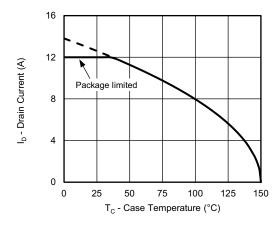


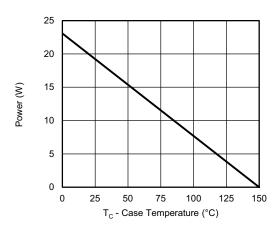
Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient







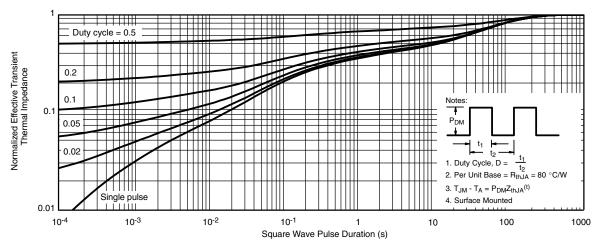
Current Derating a

Power, Junction-to-Case

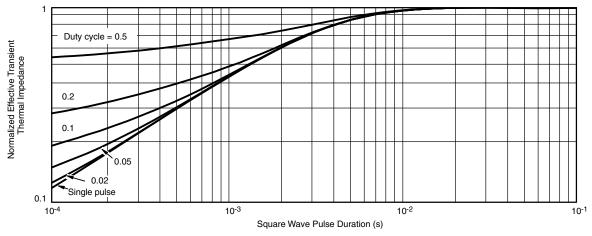
Note

a. The power dissipation P_D is based on T_J max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?76002.





Vishay Siliconix

PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
 Package outline exclusive of mold flash and metal burr
 Package outline inclusive of plating

| | | | SINGL | _E PAD | | | DUAL PAD | | | | | | |
|-----------|--------|-----------|-------|-----------|-----------|-------|-----------|-----------|-------|-----------|-----------|-------|--|
| DIM | M | ILLIMETER | RS | | INCHES | | M | ILLIMETER | RS | | INCHES | | |
| | Min | Nom | Max | Min | Nom | Max | Min | Nom | Max | Min | Nom | Max | |
| Α | 0.675 | 0.75 | 0.80 | 0.027 | 0.030 | 0.032 | 0.675 | 0.75 | 0.80 | 0.027 | 0.030 | 0.032 | |
| A1 | 0 | - | 0.05 | 0 | - | 0.002 | 0 | - | 0.05 | 0 | - | 0.002 | |
| b | 0.23 | 0.30 | 0.38 | 0.009 | 0.012 | 0.015 | 0.23 | 0.30 | 0.38 | 0.009 | 0.012 | 0.015 | |
| С | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 | |
| D | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 | |
| D1 | 0.85 | 0.95 | 1.05 | 0.033 | 0.037 | 0.041 | 0.513 | 0.613 | 0.713 | 0.020 | 0.024 | 0.028 | |
| D2 | 0.135 | 0.235 | 0.335 | 0.005 | 0.009 | 0.013 | | | | | | | |
| Е | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 | |
| E1 | 1.40 | 1.50 | 1.60 | 0.055 | 0.059 | 0.063 | 0.85 | 0.95 | 1.05 | 0.033 | 0.037 | 0.041 | |
| E2 | 0.345 | 0.395 | 0.445 | 0.014 | 0.016 | 0.018 | | | | | | | |
| E3 | 0.425 | 0.475 | 0.525 | 0.017 | 0.019 | 0.021 | | | | | | | |
| е | | 0.65 BSC | | | 0.026 BSC | , | | 0.65 BSC | | | 0.026 BSC | | |
| K | | 0.275 TYP | 1 | | 0.011 TYP | | 0.275 TYP | | | 0.011 TYP | | | |
| K1 | | 0.400 TYP | 1 | | 0.016 TYP | | | 0.320 TYP | | | 0.013 TYP | | |
| K2 | | 0.240 TYP | 1 | | 0.009 TYP | | | 0.252 TYP | | | 0.010 TYP | | |
| К3 | | 0.225 TYP | 1 | 0.009 TYP | | | | | | | | | |
| K4 | | 0.355 TYP | 1 | | 0.014 TYP | | | | | | | | |
| L | 0.175 | 0.275 | 0.375 | 0.007 | 0.011 | 0.015 | 0.175 | 0.275 | 0.375 | 0.007 | 0.011 | 0.015 | |
| Т | | | | | | | 0.05 | 0.10 | 0.15 | 0.002 | 0.004 | 0.006 | |
| ECNI- C C | 7404 D | . 0 00 1 | . 07 | | | | | | | | | | |

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RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Single



Dimensions in mm/(Inches)

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ATTLICATION NOT



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